

Specification for

Harmonized system of quality assessment for electronic components: Basic specification: Sampling plans and procedures for inspection by attributes

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Co-operating organizations

The Management Committee for Electronic Components of Assessed Quality under whose supervision this British Standard was prepared, consists of representatives from the following Government departments and scientific and industrial organizations:

- Association of Manufacturers Associated to the Electrical and Electronic Industry*
- British Industrial Measuring and Control Apparatus Manufacturers' Association (BEAMA)
- Department of Prices and Consumer Protection (SWM)*
- Control and Automation Manufacturers' Association (BEAMA)*
- EIEMA (BEAMA)
- Electronic Components Board*
- Electronic Engineering Association*
- Engineering Equipment Users Association
- Ministry of Defence*
- Post Office*
- Scientific Instrument Manufacturers' Association*
- Society of British Aerospace Companies*
- Telecommunication Engineering and Manufacturing Association*
- TACMA (BEAMA)*

The Government departments and scientific and industrial organization, marked with an asterisk, in the above list, together with the following, were directly represented on the committee entrusted with the preparation of this British Standard:

- Association of Franchised Distributors of Electronic Components
- British Broadcasting Corporation
- Electricity Supply Industry in England and Wales
- Radio and Electronic Component Manufacturers' Federation

This British Standard, having been approved by the Management Committee for Electronic Components of Assessed Quality, was published under the authority of the Executive Board on 31 January 1975

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Contents

	Page
Co-operating organizations	Inside front cover
Foreword	ii
1 General	1
2 Interpretations	1
Appendix A The CENELEC Electronic Components Committee (CECC)	2